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ON Semiconductor®

FDMC86102LZ

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 22 A, 24 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 24 m Ω at V_{GS} = 10 V, I_D = 6.5 A
- Max $r_{DS(on)} = 35 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 5.5 \text{ A}$
- HBM ESD protection level > 6 KV typical (Note 4)
- 100% UIL Tested
- RoHS Compliant



General Description

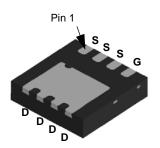
This N-Channel logic Level MOSFETs are produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance. G-S zener has been added to enhance ESD voltage level.

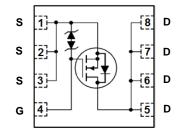
Application

■ DC - DC Switching

Top Bottom







MLP 3.3x3.3

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame	ter		Ratings	Units
V_{DS}	Drain to Source Voltage			100	V
V_{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous	T _C = 25 °C		22	
I_D	-Continuous	T _A = 25 °C	(Note 1a)	7	Α
	-Pulsed			30	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ
D	Power Dissipation	T _C = 25 °C		41	W
P_{D}	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	VV
T _J , T _{STG}	Operating and Storage Junction Temperat	ture Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	3	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	53	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC86102Z	FDMC86102LZ	Power 33	13 "	12 mm	3000 units

Electrical Characteristics T_J = 25 °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		71		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±10	μΑ

On Characteristics

V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	1.0	1.6	2.2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-6		mV/°C
		$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}$		19	24	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5 \text{ V}, I_D = 5.5 \text{ A}$		25	35	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 6.5 \text{ A}, T_J = 125 \text{ °C}$		31	40	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 6.5 A		24		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 50 V V 0 V	969	1290	pF
C _{oss}	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz	181	240	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1 1011 12	9	15	pF
R_g	Gate Resistance		0.4		Ω

Switching Characteristics

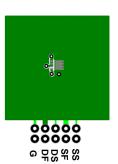
t _{d(on)}	Turn-On Delay Time		7.1	15	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 6.5 A,	2.3	10	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω	19	35	ns
t _f	Fall Time		2.5	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V _{GS} = 0 V to 10 V	15.3	22	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 50 \text{ V},$ $I_{D} = 6.5 \text{ A}$	7.6	11	nC
Q_{gs}	Total Gate Charge	1 _D = 6.5 A	2.4		nC
Q_{gd}	Gate to Drain "Miller" Charge		2.5		nC

Drain-Source Diode Characteristics

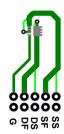
V	Ved Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 6.5 \text{ A}$	(Note 2)	0.80	1.3	V
v _{SD}		$V_{GS} = 0 \text{ V}, I_{S} = 2 \text{ A}$	(Note 2)	0.72	1.2	v
t _{rr}	Reverse Recovery Time	I _F = 6.5 A, di/dt = 100 A/μs		37	59	ns
Q _{rr}	Reverse Recovery Charge			27	43	nC

NOTES:

^{1.} R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a. 53 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

- 2. Pulse Test: Pulse Width < 300 $\mu\text{s},$ Duty cycle < 2.0%.
- 3. Starting T_J = 25 °C; N-ch: L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.
- 4. The diode connected between gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

Typical Characteristics T_J = 25 °C unless otherwise noted

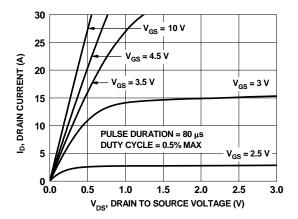


Figure 1. On-Region Characteristics

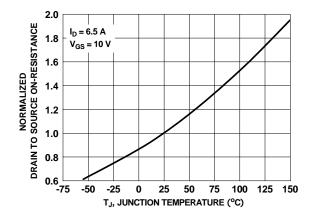


Figure 3. Normalized On-Resistance vs. Junction Temperature

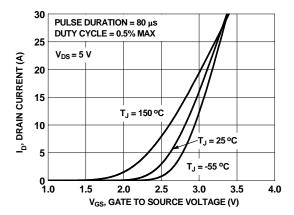


Figure 5. Transfer Characteristics

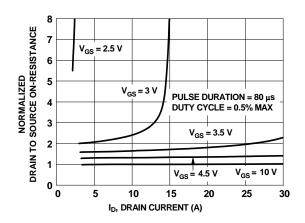


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

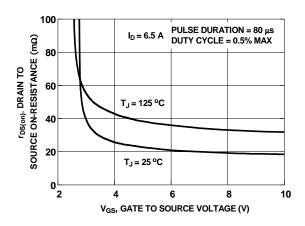


Figure 4. On-Resistance vs. Gate to Source Voltage

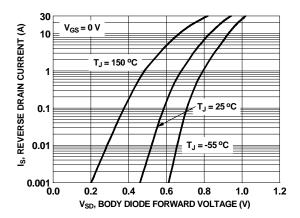


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted

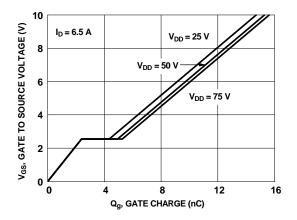


Figure 7. Gate Charge Characteristics

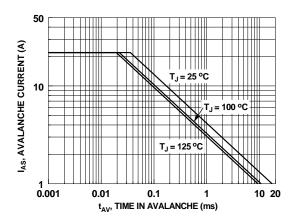


Figure 9. Unclamped Inductive Switching Capability

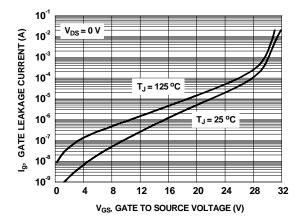


Figure 11. Gate Leakage Current vs. Gate to Source Voltage

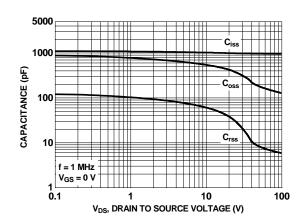


Figure 8. Capacitance vs. Drain to Source Voltage

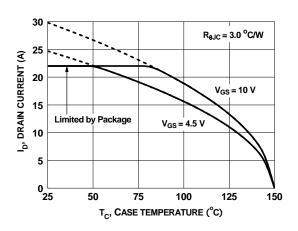


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

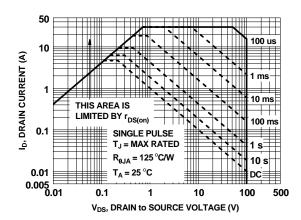


Figure 12. Forward Bias Safe Operating Area

Typical Characteristics T_J = 25 °C unless otherwise noted

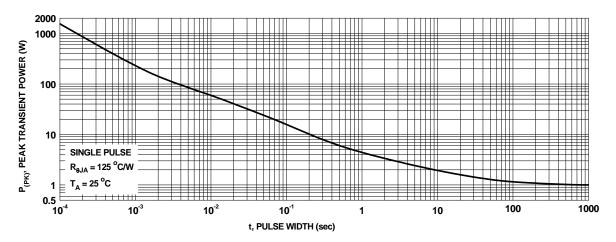


Figure 13. Single Pulse Maximum Power Dissipation

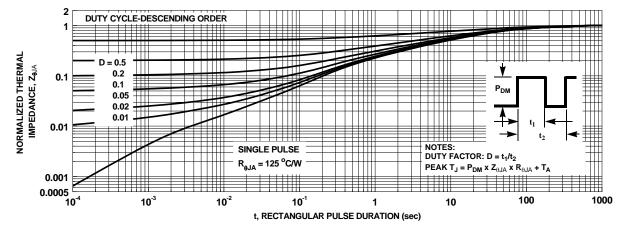


Figure 14. Junction-to-Ambient Transient Thermal Response Curve

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